

C1210X271GATACTU

Aliases (C1210X271GATAC7800)

SMD Comm X8G HT150C Flex, Ceramic, 270 pF, 2%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 1210, 1.5 mm



General Information	
Series	SMD Comm X8G HT150C Flex
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable
Features	High Temperature, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	30 mg
Shelf Life	78 Weeks
MSL	1

270 pF

Dimensions	
Chip Size	1210
L	3.3mm +/-0.4mm
W	2.6mm +/-0.3mm
Т	0.78mm +/-0.20mm
S	1.5mm MIN
В	0.6mm +/-0.25mm

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Т	0.78mm +/-0.20mm
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В	0.6mm +/-0.25mm
Packaging Specifications	

Packaging

Packaging Quantity

	3.3mm +/-0.4mm	Measurement Condition	1 MHz 1.0Vrms
	2.6mm +/-0.3mm	Tolerance	2%
	0.78mm +/-0.20mm	Voltage DC	250 VDC
	1.5mm MIN	Dielectric Withstanding Voltage	625 VDC
	0.6mm +/-0.25mm	Temperature Range	-55/+150°C
		Temp. Coefficient	X8G
5	T&R, 180mm, Plastic Tape	Capacitance Change with Reference to +25°C and 0 VDC	30 ppm/C, 1MegaHz 1.0Vrms
	Tak, Ioomin, Flastic Tape	Applied (TCC)	
	4000	Applied (TCC) Dissipation Factor	0.1% 1 MHz 1.0Vrms
			0.1% 1 MHz 1.0Vrms 0% Loss/Decade Hour: Referee Time is 1000 Hours

Specifications

Capacitance

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